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October 2014

FDMS8622

N-Channel Shielded Gate PowerTrench[®] MOSFET 100 V, 16.5 A, 56 m Ω

Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 56 m Ω at V_{GS} = 10 V, I_D = 4.8 A
- Max $r_{DS(on)}$ = 88 m Ω at V_{GS} = 6 V, I_D = 3.9 A
- High performance trench technology for extremely low r_{DS(on)}
- High power and current handling capability in a widely used surface mount package
- 100% UIL Tested
- Termination is Lead-free and RoHS Compliant

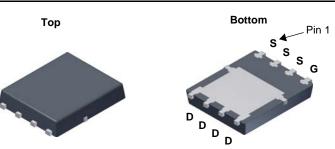
General Description

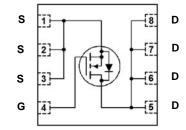
This N-Channel MOSFET is produced using Fairchild Semiconductor's advanced PowerTrench process that incorporates Shielded Gate technology. This process has been optimized for $r_{DS(on)}$, switching performance and ruggedness.

Applications

- POE Protection Switch
- DC-DC Switch







Power 56

MOSFET Maximum Ratings T_A = 25 °C unless otherwise noted

Symbol	Parame	eter		Ratings	Units
V_{DS}	Drain to Source Voltage			100	V
V _{GS}	Gate to Source Voltage			±20	V
I _D	Drain Current -Continuous	T _C = 25 °C		16.5	
	-Continuous	T _A = 25 °C	(Note 1a)	4.8	Α
	-Pulsed			30	
E _{AS}	Single Pulse Avalanche Energy		(Note 3)	12	mJ
P _D	Power Dissipation	T _C = 25 °C		31	W
	Power Dissipation	T _A = 25 °C	(Note 1a)	2.5	VV
T _J , T _{STG}	Operating and Storage Junction Tempera	ature Range		-55 to +150	°C

Thermal Characteristics

$R_{\theta JC}$	Thermal Resistance, Junction to Case	(Note 1)	4	°C/W
$R_{\theta,IA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	50	C/VV

Package Marking and Ordering Information

Device Marking	Device	Package	Reel Size	Tape Width	Quantity
FDMS8622	FDMS8622	Power56	13 "	12 mm	3000 units

Electrical Characteristics $T_J = 25$ °C unless otherwise noted

Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Chara	octeristics					
BV _{DSS}	Drain to Source Breakdown Voltage	$I_D = 250 \mu A, V_{GS} = 0 V$	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_{J}}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		69		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{DS} = 80 \text{ V}, V_{GS} = 0 \text{ V}$			1	μА
I _{GSS}	Gate to Source Leakage Current	V _{GS} = ±20 V, V _{DS} = 0 V			±100	nA

On Characteristics

$V_{GS(th)}$	Gate to Source Threshold Voltage	$V_{GS} = V_{DS}, I_D = 250 \mu A$	2	3	4	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 250 μ A, referenced to 25 °C		-8		mV/°C
r _{DS(on)}	Static Drain to Source On Resistance	$V_{GS} = 10 \text{ V}, I_D = 4.8 \text{ A}$		45	56	
		$V_{GS} = 6 \text{ V}, I_D = 3.9 \text{ A}$		62	88	$m\Omega$
		$V_{GS} = 10 \text{ V}, I_D = 4.8 \text{ A}, T_J = 125 \text{ °C}$		78	97	
9 _{FS}	Forward Transconductance	V _{DD} = 5 V, I _D = 4.8 A		9		S

Dynamic Characteristics

C _{iss}	Input Capacitance	V _{DS} = 50 V, V _{GS} = 0 V, f = 1 MHz	301	400	pF
Coss	Output Capacitance		70	95	pF
C _{rss}	Reverse Transfer Capacitance		3.6	5	pF
R_g	Gate Resistance		1.0		Ω

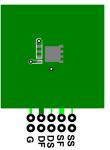
Switching Characteristics

	J				
t _{d(on)}	Turn-On Delay Time		5.7	11	ns
t _r	Rise Time	V _{DD} = 50 V, I _D = 4.8 A,	1.7	10	ns
t _{d(off)}	Turn-Off Delay Time	$V_{GS} = 10 \text{ V}, R_{GEN} = 6 \Omega$	10.2	18	ns
t _f	Fall Time		2.1	10	ns
$Q_{g(TOT)}$	Total Gate Charge	V _{GS} = 0 V to 10 V	5	7	nC
$Q_{g(TOT)}$	Total Gate Charge	$V_{GS} = 0 \text{ V to 5 V}$ $V_{DD} = 50 \text{ V},$ $I_{D} = 4.8 \text{ A}$	2.8	4	nC
Q _{gs}	Total Gate Charge	I _D = 4.8 A	1.4	2.8	nC
Q_{qd}	Gate to Drain "Miller" Charge		1.3	2.6	nC

Drain-Source Diode Characteristics

V _{SD} Source to Drain Diode Forward \	Source to Drain Diade, Forward Voltage	$V_{GS} = 0 \text{ V}, I_S = 4.8 \text{ A}$ (Note 2)	0.8	1.3	\/
	Source to Drain Diode Forward voltage	$V_{GS} = 0 \text{ V}, I_S = 1.9 \text{ A}$ (Note 2)	0.8	1.2	V
t _{rr}	Reverse Recovery Time	I _F = 4.8 A, di/dt = 100 A/μs	38	60	ns
Q _{rr}	Reverse Recovery Charge	iF = 4.0 A, αί/αι = 100 A/μs	30	48	nC

^{1.} $R_{\theta JA}$ is determined with the device mounted on a 1in² pad 2 oz copper pad on a 1.5 x 1.5 in. board of FR-4 material. $R_{\theta JC}$ is guaranteed by design while $R_{\theta CA}$ is determined by the user's board design.



a) 50 °C/W when mounted on a 1 in² pad of 2 oz copper



b) 125 °C/W when mounted on a minimum pad of 2 oz copper.

^{2.} Pulse Test: Pulse Width < 300 μ s, Duty cycle < 2.0%. 3. Starting T_J = 25 °C; N-ch: L = 0.1 mH, I_{AS} = 16 A, V_{DD} = 90 V, V_{GS} = 10 V.

Typical Characteristics T_J = 25 °C unless otherwise noted

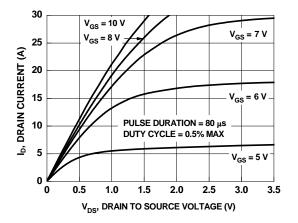


Figure 1. On Region Characteristics

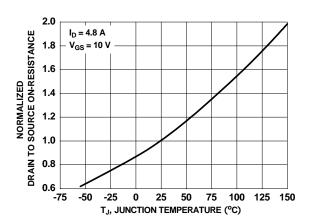


Figure 3. Normalized On Resistance vs Junction Temperature

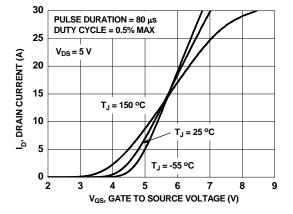


Figure 5. Transfer Characteristics

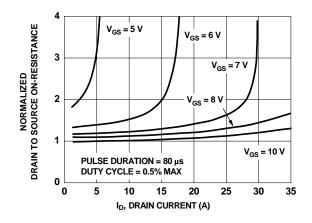


Figure 2. Normalized On-Resistance vs Drain Current and Gate Voltage

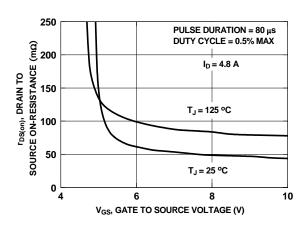


Figure 4. On-Resistance vs Gate to Source Voltage

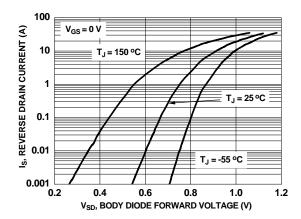


Figure 6. Source to Drain Diode Forward Voltage vs Source Current

Typical Characteristics $T_J = 25$ °C unless otherwise noted

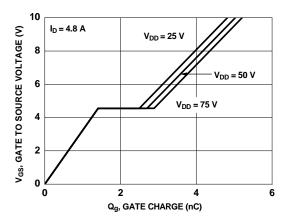


Figure 7. Gate Charge Characteristics

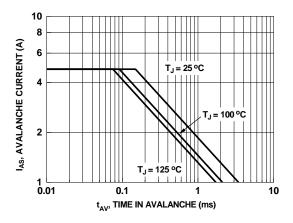


Figure 9. Unclamped Inductive Switching Capability

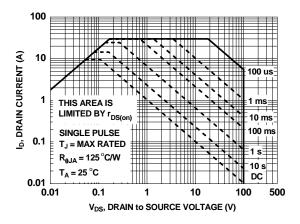


Figure 11. Forward Bias Safe Operating Area

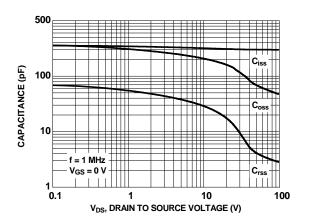


Figure 8. Capacitance vs Drain to Source Voltage

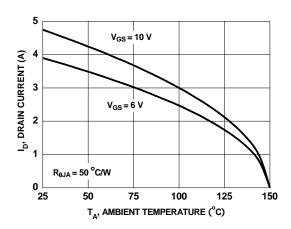


Figure 10. Maximum Continuous Drain Current vs Ambient Temperature

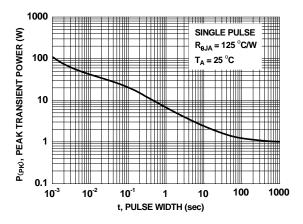


Figure 12. Single Pulse Maximum Power Dissipation

Typical Characteristics $T_J = 25$ °C unless otherwise noted

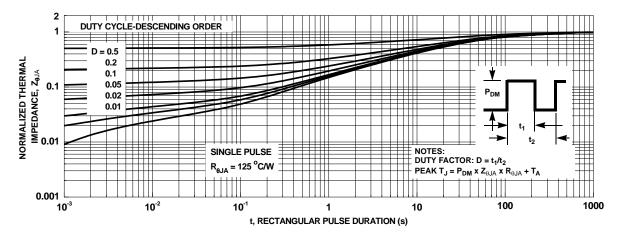


Figure 13. Junction-to-Ambient Transient Thermal Response Curve



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